APDS-9200

Digital UV and Ambient Light Sensor

Data Sheet

Description

The Broadcom APDS-9200 device provides ultra-violet (UV-A and UV-B) sensing and ambient light sensing in a specially designed matrix arrangement for optimization. This allows the device to have optimal angular response for ultra-violet and ambient light sensing. The APDS-9200 converts UV light into digital data and display as UV index (1… >11) with higher values representing higher UV exposures.

The ultra-violet sensing feature is useful in consumer applications for monitoring of UV-A and UV-B radiation as UV radiation is part of the electromagnetic spectrum that reaches the earth from the sun. APDS-9200 is able to measure UV wavelength which has been classified into UV-A (320 nm – 400 nm) and UV-B (290 nm – 320 nm). The ambient light sensing is targeted for display management with the purpose of extending battery life and offers optimum viewing in diverse lightning conditions.

APDS-9200 supports the I^2C interface and has a programmable interrupt function that frees up micro-controller resources using upper and lower thresholds events.

Ordering Information

Features

- Ultra-Violet (UV-A and UV-B) and ambient light sensing
	- **—** Digital UV Index register (1 … > 11)
	- **—** Linear output
	- **—** Excellent temperature compensation
- Ambient Light Sensing (ALS)
	- **—** Utilizes coating technology to emulate human eye spectral response (V-Lamda characteristics)
	- **—** High sensitivity in low lux condition Ideally suited for operation behind dark glass
	- **—** Low lux performance at 0.008 lux
	- **—** Up to 20-bit resolution
- I²C Interface Compatible
	- **—** Up to 400 kHz (I2C Fast-Mode)
	- **—** Dedicated interrupt pin
- Small package: L 2.0 mm \times W 2.0 mm \times H 0.65 mm

Applications

- Ultra-violet and Ambient Light Sensing
- Mobile devices cell phones, tablets, outdoor navigation display
- Wearable devices smart watch, sport watch

Figure 1 Functional Block Diagram

Detailed Description

The APDS-9200 device contains multiple photodiodes for UV and Ambient Light Sensing as well as temperature compensation that are designed in a matrix placement to achieve optimum angular response at the fall of incident light angle. The photodiode currents are converted to digital count by ADCs. The ADC resolution is selected from 13 bits to 20 bits and the conversion time is inversely proportional to the ADC resolution. The device is connected by an I²C interface to a microcontroller through a set of registers. APDS-9200 has a programmable interrupt with hysteresis to respond to events which will reduce the microcontroller tasks with upper and lower thresholds. The device includes a circuit for an internal oscillator, a current source, voltage reference, and internal nonvolatile memory (NVM) to store trimming information.

The UV light sensor has to be operated independently from Ambient Light Sensor. To enable the reading of UV sensor, UVS_MODE and LS_EN bit has to be correctly set in the MAIN_CTRL register. Setting the UVS_MODE bit will stop a running ALS measurement and start a new UV sensor reading.

Table 2 Absolute Maximum Ratings over Operating Free-Air Temperature Range (unless Otherwise Noted)

Table 3 Recommended Operating Conditions

Table 4 Electrical Parameters, T_A=25°C (unless Otherwise Noted)

Table 5 ALS/UV Characteristics

Figure 2 ALS Spectral Response Figure 3 UV Spectral Response

Figure 6 ALS Sensor LUX vs. Meter LUX using Incandescent Light Figure 7 UV Sensor Count vs. UV Meter Index (310 nm UV Source)

Figure 4 ALS Sensor LUX vs. Meter LUX using White Light **Figure 5 ALS Sensor LUX vs. Meter LUX using White Light**

Figure 8 Normalized Standby IDD vs. VDD **Figure 9 Normalized Standby IDD vs. Temperature**

Figure 10 Normalized ALS Data Count @ 1000Lux White LED vs. VDD

Figure 11 Normalized UVS Data Count @ 121 µW/cm² (310 nm) vs. VDD

Figure 12 Normalized ALS Data Count @ 2.8V vs. Temperature Figure 13 Normalized UVS Data Count @ 121 µW/cm² (310nm) VDD = 2.8V vs. Temperature

Figure 14 Normalized ALS Responsitivity vs. Angular Displacement

Figure 15 System State Machine

Start Up after Power-On or Software Reset

The main state machine is set to "Start State" during power-on or software reset. As soon as the reset is released, the internal oscillator is started and the programmed I²C address and the trim values are read from the internal trimming data block. The APDS-9200 enters Standby Mode as soon as the idle state is reached.

NOTE As long as the I²C address has not yet been read, the device will respond with NACK to any I^2C command and ignore any request to avoid responding to a wrong I²C address.

Standby Mode

Standby Mode is the default mode after power-up. In this state, the oscillator, all internal support blocks, and the ADCs are switched off but 1^2 C[™] communication is fully supported.

ALS and UVS Operation

ALS measurements can be activated by setting the LS_EN bit to 1 and the UVS Mode bit to 0 in the MAIN_CTRL register.

UV measurements can be activated by setting the LS_EN bit to 1 and the UVS_Mode bit to 1 in the MAIN_CTRL register.

As soon as ALS or UVS become activated through an I²C command, the internal support blocks are powered on. Once the voltages and currents are settled (typically after 5 ms), the state machine checks for trigger events from a measurement scheduler to start the ALS or UVS conversions according to the selected measurement repeat rates.

Once LS EN is changed back to 0, a conversion running on the respective channel will be completed and the relevant ADCs and support blocks will move to standby mode.

Interrupt Features

APDS-9200 generates independent Light sensor (ALS/UVS depend on configuration) interrupt signal that can be multiplexed and output to the INT pad. The interrupt conditions are always evaluated after completion of a new conversion on the LS channels.

Light Sensor Interrupt

The LS interrupt is enabled by LS INT $EN = 1$. It can function as either threshold triggered (LS_VAR_MODE = 0) or variance trigged (LS_VAR_MODE = 1). The LS interrupt source generator either uses the ALS_DATA or the UVS_DATA registers at input. The LS interrupt source is selected by the LS_INT_SEL bits in the INT_CFG register.

The Light Sensor threshold interrupt is enabled with LS _INT_EN = 1 and LS _VAR_MODE = 0. It is set when the data of the selected LS_DATA input register (ALS_DATA or UVS_DATA) is above the upper or below the lower threshold for a specified number of consecutive measurements.

The Light Sensor variance interrupt is enabled with LS _INT_EN = 1 and LS _VAR_MODE = 1. It is set when the absolute value of the difference between the previous and current LS_DATA data value is above the decoded LS variance threshold for a specified number of consecutive measurements.

I ²C Protocol

Interface and control of the APDS-9200 is accomplished through an I^2C serial compatible interface (standard or fast mode) to a set of registers that provide access to device control functions and output data. The device supports a single slave address of 0x52 hex using 7 bit addressing protocol. (Contact the factory for other addressing options.)

I ²C Register Read

The registers can be read individually or in block read mode. When two or more bytes are read in block read mode, reserved register addresses are skipped and the next valid address is referenced. If the last valid address has been reached, but the master continues with the block read, the address counter in the device will not roll over and the device returns 00HEX for every subsequent byte read.

The block read operation is the only way to ensure correct data read out of multi-byte registers and to avoid splitting of results with HIGH and LOW bytes originating from different conversions. During block read access on LS result registers, the result update is blocked.

If a read access is started on an address belonging to a non-readable register, the APDS-9200 will re-turn NACK until the I^2C operation is ended.

Read operations must follow the timing diagram in [Figure 16](#page-6-0).

I ²C Register Write

The APDS-9200 registers can be written to individually or in block write mode. When two or more bytes are written in block write mode, reserved registers and read-only registers are skipped. The transmitted data is automatically applied to the next writable register. If a register includes read (R) and read/write (RW) bits, the register is not skipped. Data written to read-only bits are ignored.

If the last valid address of the APDS-9200 address range is reached but the master attempts to continue the block write operation, the address counter of the APDS-9200 will not roll over. The device will return NACK for every following byte sent by the master until the 1^2C^m operation is ended.

If a write access is started on an address belonging to a non-writeable register, the APDS-9200 will return NACK until the 1^2C^m operation is ended.

Write operations must follow the timing diagram in [Figure 17](#page-6-1).

Figure 16 I2C Register Read

Figure 18 I2C Interface – Bus Timing

Table 6 Bus Timing Characteristics

Register Set

The APDS-9200 is controlled and monitored by data registers and a command register accessed through the serial interface. These registers provide for a variety of control functions and can be read to determine results of the ADC conversions.

NOTE Light Sensor (LS) refers to Ambient Light Sensor (ALS) or UV Sensor (UVS).

Table 7 Register Set

MAIN_CTRL

Default Value: 00HEX

LS_MEAS_RATE

Default Value: 22HEX

When the measurement repeat rate is programmed to be faster than possible for the specified ADC measurement time, the repeat rate will be lower than programmed (maximum speed).

Writing to this register stops the ongoing measurements and starts new measurements (depends on the respective bit).

ALS_GAIN and UVS_Gain

Default Value: 01HEX

Writing to this register stops the ongoing measurements and starts new measurements (depends on the respective bit).

PART_ID

Default Value: B1HEX

MAIN_STATUS

Default Value: 20HEX

ALS_DATA

Default Value: 00HEX, 00HEX, 00HEX

ALS channel digital output data (unsigned integer, 13 to 20 bit, LSB aligned).

The ALS channel output is already temperature compensated internally: ALS_DATA = (ALSint – COMP).

When an I²C[™] read operation is active and points to an address in the range 07HEX to 18HEX, all registers in this range are locked until the I^2C^m read operation is completed or this address range is left.

This guarantees that the data in the registers comes from the same measurement even if an additional measurement cycle ends during the read operation. New measurement data is stored into temporary registers and the actual ALS_DATA registers are updated as soon as there is no on-going I2C™ read operation to the address range 07HEX to 18HEX.

UVS_DATA

Default Value: 00HEX, 00HEX, 00HEX

UVS channel digital output data (unsigned integer, 13 to 20 bit, LSB aligned).

The UVS channel output is already temperature compensated internally: UVS_DATA = (UVint – UVS_COMP)

When an 1^2C^m read operation is active and points to an address in the range 07HEX to 18HEX, all registers in this range are locked until the I^2C^m read operation is completed or this address range is left.

This guarantees that the data in the registers comes from the same measurement even if an additional measurement cycle ends during the read operation. New measurement data is stored into temporary registers and the actual UVS_DATA registers are updated as soon as there is no on-going I^2C^m read operation to the address range 07HEX to 18HEX.

UVS_COMP_DATA

Default Value: 00HEX, 00HEX, 00HEX

UVS Compensation Channel digital output data (unsigned integer, 13 to 20 bit, LSB aligned). The UVS Comp Channel data is clipped at (2Resolution – 1).

When an 1^2C^m read operation is active and points to an address in the range 07HEX to 18HEX, all registers in this range are locked until the I^2C^m read operation is completed or this address range is left.

This guarantees that the data in the registers comes from the same measurement even if an additional measurement cycle ends during the read operation. New measurement data is stored into temporary registers and the actual UVS_COMP_DATA registers are updated as soon as there is no on-going I^2C^m read operation to the address range 07HEX to 18HEX.

COMP_DATA

Default Value: 00HEX, 00HEX, 00HEX

ALS compensation channel digital output data (unsigned integer, 13 to 20 bit, LSB aligned). The compensation channel data is clipped at (2Resolution – 1).

If an 1^2 C read operation is active and points to an address in the range 07HEX to 18HEX, all registers in this range are locked until the $1²C$ read operation is completed or this address range is left.

This guarantees that the data in the registers comes from the same measurement even if an additional measurement cycle ends during the read operation. New measurement data is stored into temporary registers and the actual COMP_DATA registers are updated as soon as there is no on-going ²C read operation to the address range 07HEX to 18HEX.

INT_CFG

Default Value: 10HEX

INT_PERSISTENCE

Default Value: 00HEX

LS_THRES_UP

Default Value: FFHEX, FFHEX, 0FHEX

LS_THRES_UP_x sets the upper threshold value for the LS interrupt. The Interrupt Controller compares the value in LS_THRES_UP_x against measured data in the DATA_x registers of the selected LS interrupt channel. It generates an interrupt event if DATA_x exceeds the threshold level.

The data format for LS_THRES_UP_x must match that of the DATA_x registers.

LS_THRES_LOW

Default Value: 00HEX, 00HEX, 00HEX

LS_THRES_LOW_x sets the lower threshold value for the LS interrupt. The Interrupt Controller compares the value in LS_THRES_LOW_x against measured data in the DATA_x registers of the selected LS interrupt channel. It generates an interrupt event if the DATA_x is below the threshold level.

The data format for LS_THRES_LOW_x must match that of the DATA_x registers.

LS_THRES_VAR

Default Value: 00HEX

Application Information Hardware

The application hardware circuit for using implementing UVS and ALS is simple with the APDS-9200 and is shown in following figure. The bypass capacitor is placed as close to the device package and is connected directly to the power source and to the ground, as shown in the following figure. It allows the AC component of the V_{DD} to pass through to ground. It is suggested to have bypass capacitor that have low effective series resistance (ESR) and low effective series inductance (ESI), such as the common ceramic types, which provide a low impedance path to ground at high frequencies to handle transient currents caused by internal logic switching.

Pull-up resistors, RSDA and RSCL, maintain the SDA and SCL lines at a high level when the bus is free and ensure the signals are pulled up from a low to a high level within the required rise time. A pull-up resistor, R_{INT} , is also required for the interrupt (INT), which functions as a wired-AND signal in a similar fashion to the SCL and SDA lines. A typical impedance value of 10 k Ω can be used.

For a complete description of 1^2C maximum and minimum R1 and R2 values, please review the 1^2C Specification at http://www.semiconductors.philips.com.

Figure 19 Application Hardware Circuit

Figure 20 Package Outline Dimensions

4- INT 5- NC 6- GND

NOTE All dimensions are in millimeters.

Figure 21 PCB Pad Layout

NOTE All dimensions are in millimeters.

Figure 22 Tape Dimensions

NOTE All dimensions are in millimeters.

Figure 23 Reel Dimensions

NOTE All dimensions are in millimeters.

Moisture Proof Packaging

All APDS-9200 options are shipped in moisture proof package. Once opened, moisture absorption begins. This part is compliant to JEDEC MSL 3.

Figure 24 Moisture Proof Packaging

Table 8 Baking Conditions

If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts.

Baking should only be done once.

Table 9 Recommended Storage Conditions

Time from unsealing to soldering:

After removal from the bag, the parts should be soldered within 168 hours if stored at the recommended storage conditions. If times longer than 168 hours are needed, the parts must be stored in a dry box.

Figure 25 Recommended Reflow Profile

Table 10 Reflow Information

The reflow profile is a straight-line representation of a nominal temperature profile for a convective reflow solder process. The temperature profile is divided into four process zones, each with different $\Delta T/\Delta t$ ime temperature change rates or duration. The $\Delta T/\Delta t$ ime rates or duration are detailed in the above table. The temperatures are measured at the component to printed circuit board connections.

In process zone P1, the PC board and component pins are heated to a temperature of 150°C to activate the flux in the solder paste. The temperature ramp up rate, R1, is limited to 3°C per second to allow for even heating of both the PC board and component pins.

Process zone P2 should be of sufficient time duration (100 to 180 seconds) to dry the solder paste. The temperature is raised to a level just below the liquidus point of the solder.

Process zone P3 is the solder reflow zone. In zone P3, the temperature is quickly raised above the liquidus point of solder to 260°C (500°F) for optimum results. The dwell time above the liquidus point of solder should be between 60 and 120 seconds. This is to assure proper coalescing of the solder paste into liquid solder and the formation of good solder

connections. Beyond the recommended dwell time the intermetallic growth within the solder connections becomes excessive, resulting in the formation of weak and unreliable connections. The temperature is then rapidly reduced to a point below the solidus temperature of the solder to allow the solder within the connections to freeze solid.

Process zone P4 is the cool down after solder freeze. The cool down rate, R5, from the liquidus point of the solder to 25°C (77°F) should not exceed 6°C per second maximum. This limitation is necessary to allow the PC board and component pins to change dimensions evenly, putting minimal stresses on the component.

It is recommended to perform reflow soldering no more than twice.

It is recommended to perform a calibration of the UVS ADC output against a calibrated UV test light source after final reflow and product assembly.

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